

KEMET Part Number: C1206X333M2RACTU
(C1206X333M2RAC7800)

SMD Comm X7R Flex, Ceramic, 0.033 uF, 20%, 200 VDC, X7R, SMD, MLCC, FT-CAP, Temperature Stable, 1206



Dimensions

Chip Size		1206
L		3.3mm +/-0.4mm
W		1.6mm +/-0.35mm
T		0.78mm +/-0.20mm
B		0.6mm +/-0.25mm

Packaging Specifications

Packaging:	T&R, 180mm, Plastic Tape
Packaging Quantity:	4000

General Information

Series:	SMD Comm X7R Flex
Style:	SMD Chip
Description:	SMD, MLCC, FT-CAP, Temperature Stable
Features:	FT-CAP, Temperature Stable
RoHS:	Yes
Termination:	Flexible Termination
Marking:	No
AEC-Q200:	No
Component Weight:	17 mg
Shelf Life:	78 Weeks
MSL:	1

Specifications

Capacitance:	0.033 uF
Measurement Condition:	1 kHz 1.0Vrms
Capacitance Tolerance:	20%
Voltage DC:	200 VDC
Dielectric Withstanding Voltage:	500 VDC
Temperature Range:	-55/+125°C
Temperature Coefficient:	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	15%, 1kHz 1.0Vrms
Dissipation Factor:	2.5% 1 kHz 1.0Vrms
Aging Rate:	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance:	30.303 GOhms

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